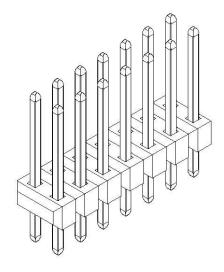


PRODUCT SPECIFICATION



SERIES 70280 / 70287

C-GRID[®] VERTICAL THROUGH HOLE .100" GRID DUAL ROW HEADER WITH BREAK OFF OPTION SERIES 70280 / 70287

1.0 SCOPE

- 2.0 PRODUCT DESCRIPTION
 - 2.1 PRODUCT NAME AND SERIES NUMBER
 - 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS
 - 2.3 SAFETY AGENCY APPROVALS
- 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS
- 4.0 RATINGS
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- 5.0 PERFORMANCE
 - 5.1 ELECTRICAL REQUIREMENTS
 - 5.2 MECHANICAL REQUIREMENTS

6.0 PACKAGING

REVISION:	ECR/ECN INFORMATION:	<u>TITLE:</u> .100	" GRID VERTICAL		SHEET No.		
D	EC No: UCP2014-2349	MO	UNT DUAL ROW		1 of 3		
	DATE: 1/6/2014	BRE	AKAWAY HEADEF	र	1010		
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:			
PS-70280		MKIPPER	JBELL	FSMITH			
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1.0 SCOPE:

This specification covers the C-Grid[®] vertical dual row header with break-off option. The wafer (header body) is designed to be easily modified to a smaller circuit size in the field if required. The mating pins are .025in (0.64mm) square and have .100in (2.54mm) grid spacing.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER

SERIES 70280: Vertical mount through hole dual row header with break off option. SERIES 70287: Vertical mount through hole dual row header with retention pins and break off option.

2.2 DIMENSIONS, PLATINGS, AND MARKINGS

The products are available in circuit sizes of 4 through 100 circuits and are end to end stackable. Product can also be ordered with selective voids. The wafer is produced from glass filled Liquid Crystal Polymer, (LCP) having a UL 94V-0 flammability rating. Mating pin lengths are .240in (6.0mm), and .320in (8.1mm) with gold or tin plating. For further details, please refer to the sales documents in section 3.0.

2.3 RECOGNIZED AGENCY APPROVALS:

- 2.3.1 Underwriters' Laboratories: E29179
- 2.3.2 Canadian Standards Association: LR19980

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS:

3.1	MOLEX DOCL	JMENTS			
	SDA-70280-00		SALES DRAWING, VERTICAL MOUNT THRO DUAL ROW HEADER WITH BREAK OFF OPT		
	SDA-70280-50	01-9999	SALES DRAWING, VERTICAL MOUNT THRO DUAL ROW HEADER WITH BREAK OFF OPT SELECTIVE VOIDS		
	SD-70280-001		SALES DRAWING, VERTICAL MOUNT THRO DUAL ROW HEADER WITH BREAK OFF OPT		
SD-70280-002		2	SALES DRAWING, VERTICAL MOUNT THROUGH HOLE DUAL ROW HEADER WITH BREAK OFF OPTION, CUSTOM HEADERS		
SDA-70280-003)3	SALES DRAWING, VERTICAL MOUNT THROUGH HOLE DUAL ROW HEADER WITH BREAK OFF OPTION		
SD-70287-003		3	SALES DRAWING, VERTICAL MOUNT THROUGH HOLE DUAL ROW HEADER WITH RETENTION PINS AND BREAK OFF OPTION		
SD-70287-004		ŀ	SALES DRAWING, VERTICAL MOUNT THROUGH HOLE DUAL ROW HEADER WITH RETENTION PINS AND BREAK OFF OPTION		
PK-70873-0090		0	PACKAGING SPECIFICATION VERTICAL MOUNT THROUGH DUAL ROW HEADER WITH BREAK OFF OPTION		
ECR/EC	N INFORMATION:	TITLE:	.100" GRID VERTICAL	SHEET No.	
EC No: UCP2014-2349			MOUNT DUAL ROW		
DATE:	1/6/2014		BREAKAWAY HEADER	2 of 3	
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DOCUMENT NUMBER:	CREATED / REVISED BY:	CHECKED BY:	APPROVED BY:				
PS-70280	MKIPPER	JBELL	FSM	ІТН			
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PRODUCT SPECIFICATION

PK-70873-0276 PACKAGING SPECIFICATION VERTICAL MOUNT THROUGH DUAL ROW HEADER WITH BREAK OFF OPTION PK-70873-0353 PACKAGING SPECIFICATION VERTICAL MOUNT THROUGH DUAL ROW HEADER WITH BREAK OFF OPTION PS-45499-002 COSMETIC SPECIFICATION **OTHER DOCUMENTS** 3.2 MIL STD 202F 4.0 RATINGS 4.1 VOLTAGE: 250 Volts D.C. 4.2 CURRENT: 3.0 Amp D.C. maximum. 4.3 **TEMPERATURE:** 4.3.1 OPERATING TEMPERATURE (ambient +30° temp rise): Gold Plated Contacts: -40 °C to +120 °C Tin Plated Contacts: -40 °C to +105 °C NON-OPERATING TEMPERATURE: -40 °C to +105 °C PERFORMANCE 5.0 **ELECTRICAL REQUIREMENTS** 5.1 5.1.1 INSULATION RESISTANCE: Greater than $1,000M\Omega$ at sea level. 5.1.2 DIELECTRIC WITHSTANDING VOLTAGE: Greater than 600 Volts at sea level. 5.1.3 TEMPERATURE RISE: 30°C maximum at rated current 5.2 **MECHANICAL REQUIREMENTS:** Header pin retention (push out force): 3 lbs minimum before soldering. 5.2.1 Durability: Mate connectors up to 25 cycles at a maximum rate of 10 5.2.2 cycles/minute prior to environmental testing. 10 milliohms maximum (change from initial). 5.3 **ENVIRONMENTAL REQUIREMENTS:** 5.3.1 THERMAL SHOCK 10 Cycles from -40°C to 105°C, ¹/₂ hour at each temperature setting. 5.3.2 CHEMICAL RESISTANCE Per Mil. Std. 202F, Method 215A. 5.3.3 SOLDERABILITY Per SMES-152. Solder coverage: 95% minimum. 5.3.4 SOLDER RESISTANCE Wave Solder Process Dip connector pin tails in solder; Solder Temperature: 245°C max. for bright tin plating 260°C max. for select gold plating Solder Duration: 5 ±0.5 seconds 6.0 **PACKAGING** Refer to section 3.0 for packaging documents **REVISION: ECR/ECN INFORMATION:** TITLE: SHEET No. .100" GRID VERTICAL EC No: UCP2014-2349 MOUNT DUAL ROW D **3** of **3 BREAKAWAY HEADER** DATE: 1/6/2014 DOCUMENT NUMBER: CREATED / REVISED BY: CHECKED BY: APPROVED BY: **PS-70280 MKIPPER** JBELL **FSMITH**

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